

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
40V	6.3mΩ@10V	60A

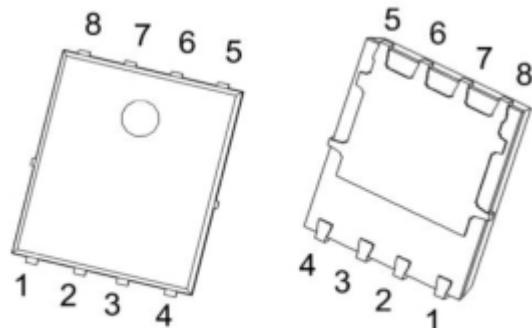
Feature

- Low On-Resistance
- Low Input Capacitance

Application

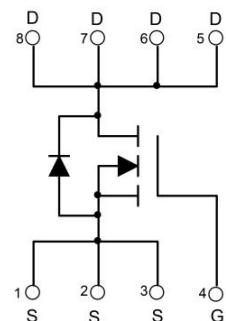
- Power Management Functions
- DC-DC Converters

Package

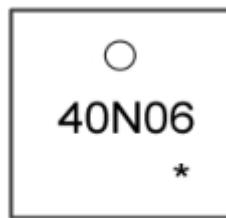


PDFNWB5X6-8L

Circuit diagram



Marking



40N06 : Product code
* : Month code.

Absolute maximum ratings

($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	60	A
Pulsed Drain Current	I_{DM}	120	A
Maximum Power Dissipation	P_D	46	W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.7	$^\circ\text{C}/\text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Electrical characteristics

($T_A=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$\text{BV}_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			± 100	μA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.5	2.5	V
Drain-Source On-State Resistance ³	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 8\text{A}$		6.3	8.5	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 4\text{A}$		9.5	12	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		1179		pF
Output Capacitance	C_{oss}			384		
Reverse Transfer Capacitance	C_{rss}			42		
Switching Characteristics						
Turn-On Delay Time	$T_{d(on)}$	$V_{DD} = 20\text{V}, I_D = 2\text{A}, R_L = 1\text{A}, V_{GS} = 10\text{V}, R_G = 3\Omega$		3.5		nS
Rise Time	T_r			3.7		
Turn-Off Delay Time	$T_{d(off)}$			17.1		
Fall Time	T_f			6.4		
Total Gate Charge	Q_g	$V_{DS} = 20\text{V}, I_D = 20\text{A}, V_{GS} = 10\text{V}$		8.3		pF
Gate-Source Charge	Q_{gs}			2.4		
Gate-Drain Charge	Q_{gd}			3.4		
Diode Characteristics						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 20\text{A}$			1.2	V
Reverse Recovery Time	t_{rr}	$T_J = 25^\circ\text{C}, I_F = 20\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}^{(3)}$		19.8		nS
Reverse Recovery Charge	Q_{rr}			8.8		nC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Typical Characteristics

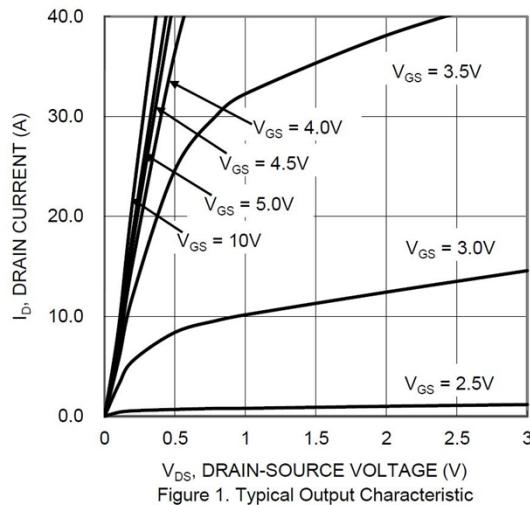


Figure 1. Typical Output Characteristic

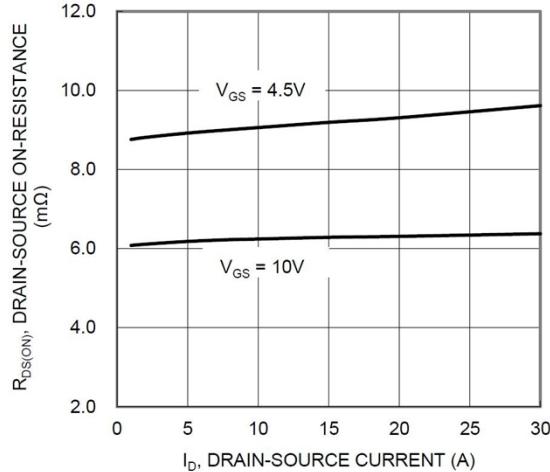


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

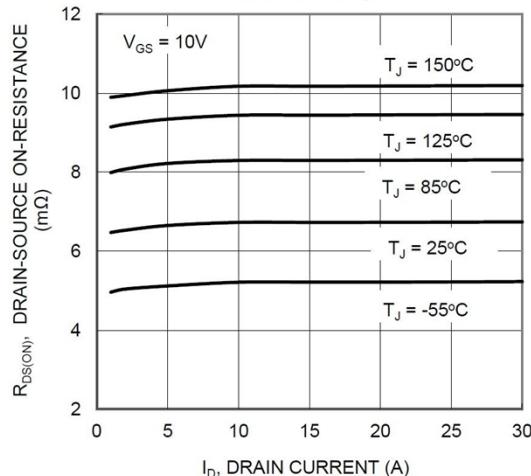


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

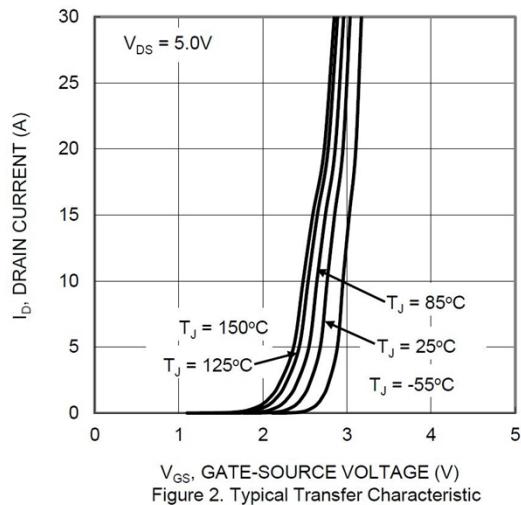


Figure 2. Typical Transfer Characteristic

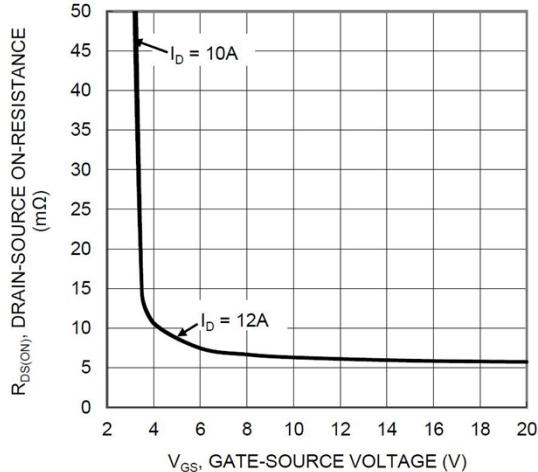


Figure 4. Typical Transfer Characteristic

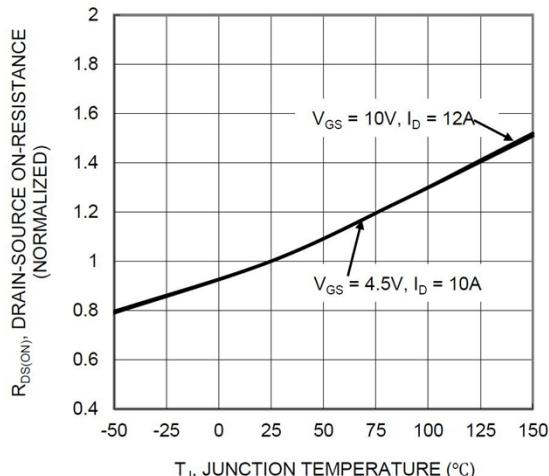


Figure 6. On-Resistance Variation with Temperature

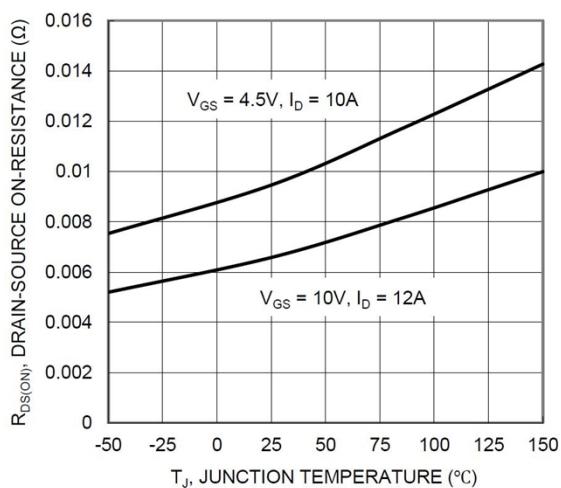


Figure 7. On-Resistance Variation with Temperature

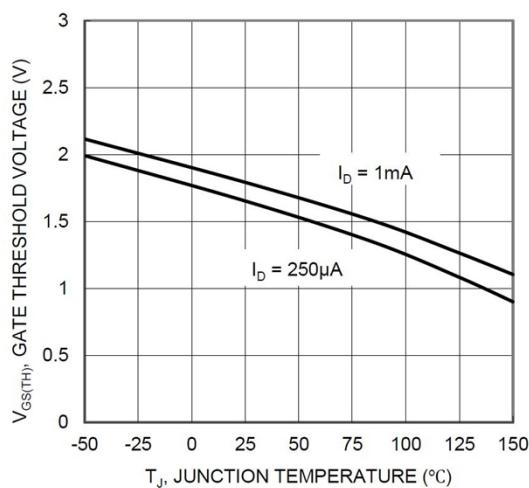


Figure 8. Gate Threshold Variation vs. Junction Temperature

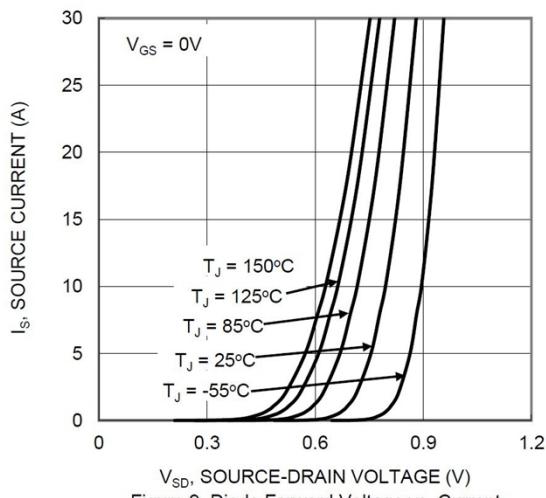


Figure 9. Diode Forward Voltage vs. Current

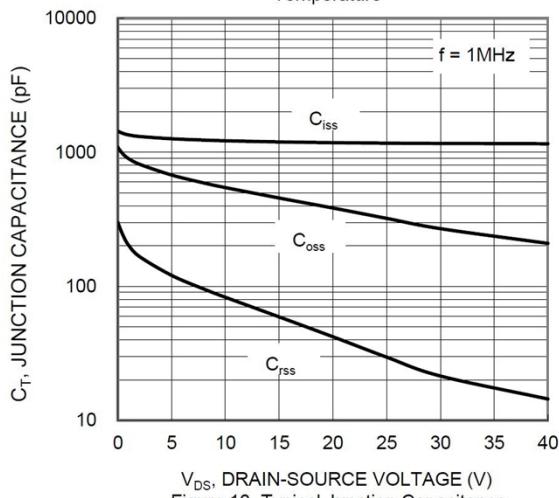


Figure 10. Typical Junction Capacitance

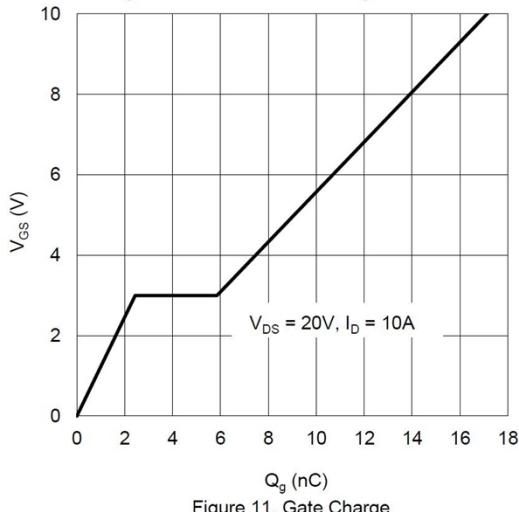


Figure 11. Gate Charge

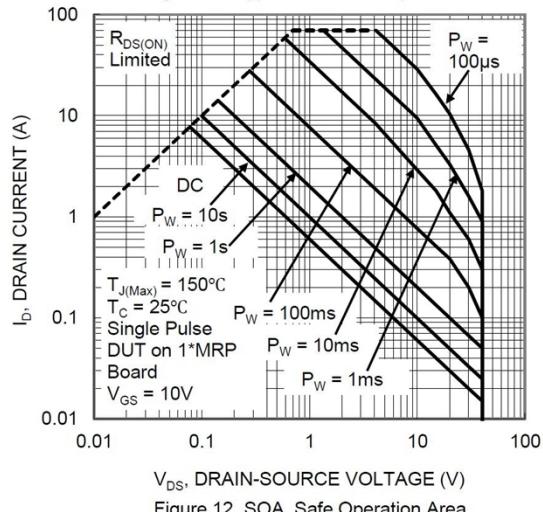


Figure 12. SOA, Safe Operation Area

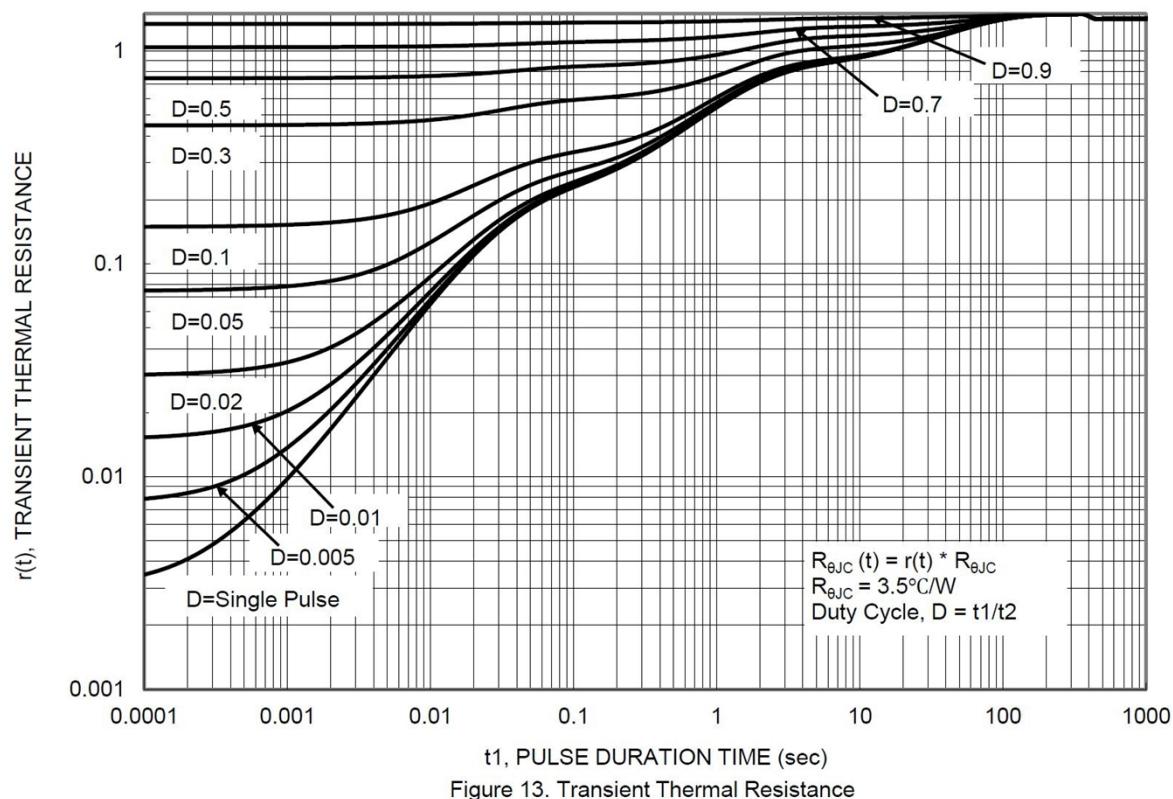
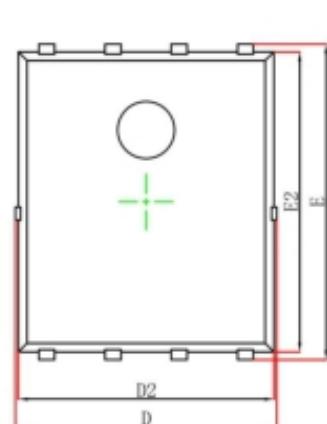
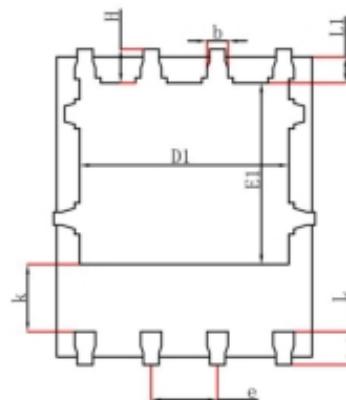


Figure 13. Transient Thermal Resistance

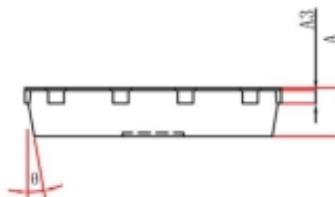
PDFNWB5X6-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°		10°	
			12°	